



40V 175°C N-CHANNEL ENHANCEMENT MODE MOSFET PowerDI5060-8

Product Summary

BV _{DSS}	R _{DS(ON)} Max	I _D T _C = +25°C
40V	10mΩ @ V _{GS} = 10V	80A

Description and Applications

This MOSFET is designed to meet the stringent requirements of automotive applications. It is qualified to AEC-Q101, supported by a PPAP and is ideal for use in:

- Engine management systems
- DC-DC converters
- Body control electronics

Features and Benefits

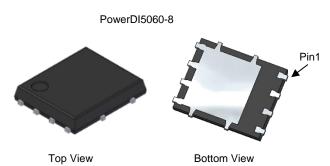
- Rated to +175°C Ideal for High Ambient Temperature Environments
- 100% Unclamped Inductive Switching Ensures More Reliable and Robust End Application
- Low Q_g Minimizes Switching Loss
- Low RDS(ON) Minimizes On State Loss
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- The DMNH4011SPSQ is suitable for automotive applications requiring specific change control; this part is AEC-Q101 qualified, PPAP capable, and manufactured in IATF 16949 certified facilities.

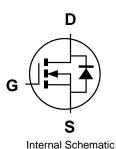
https://www.diodes.com/quality/product-definitions/

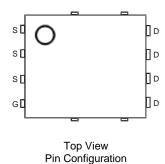
Mechanical Data

- Package: PowerDI[®]5060-8
- Package Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram Below
- Terminals: Finish Matte Tin Annealed over Copper Leadframe, Solderable per MIL-STD-202, Method 208³
- Weight: 0.097 grams (Approximate)

Site 1:







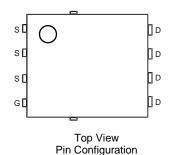
Site 2:

PowerDI5060-8/SWP (Type UX)





G S Internal Schematic



Notes:

1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.

Pin1

- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

Top View



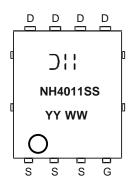
Ordering Information (Note 4)

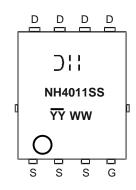
Part Number	Package	Packing		
Fait Number	Package	Qty	Carrier	
DMNH4011SPSQ-13	PowerDI5060-8	2,500	Reel	
DIVINI 140 1 13 F 3Q-13	PowerDI5060-8/SWP (Type UX)	2,500	Reel	

Note:

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information





Oli = Manufacturer's Marking
NH4011SS = Product Type Marking Code
YYWW or YYWW = Date Code Marking
YY or YY = Year (ex: 23 = 2023)
WW = Week (01 to 53)

Maximum Ratings (@TA = +25°C, unless otherwise specified.)

Characteristic Drain-Source Voltage		Symbol	Value	Unit
		VDSS	40	V
Gate-Source Voltage		Vgss	±20	V
	T _A = +25°C T _A = +70°C	lσ	13 10.8	А
Continuous Drain Current (Note 7) V _{GS} = 10V	$T_{C} = +25^{\circ}C$ $T_{C} = +100^{\circ}C$ (Note 8)	lo	80 57	А
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)		I _{DM}	90	А
Maximum Continuous Body Diode Forward Current (Note 6)		ls	80	А
Pulsed Source Current (10µs Pulse, Duty Cycle = 1%)		lsм	90	А
Avalanche Current, L = 1mH		las	18	А
Avalanche Energy, L = 1mH		Eas	170	mJ

Notes:

- 6. Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1inch square copper plate.
- 7. Thermal resistance from junction to soldering point (on the exposed drain pad).
- 8. Short duration pulse test used to minimize self-heating effect.



Thermal Characteristics

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 6)	$T_A = +25$ °C	PD	2.5	W
Thermal Resistance, Junction to Ambient (Note 6)		Reja	60	°C/W
Total Power Dissipation (Note 7)	Tc = +25°C	PD	150	W
Thermal Resistance, Junction to Case (Note 7)		Rejc	1	°C/W
Operating and Storage Temperature Range		T _J , T _{STG}	-55 to +175	°C

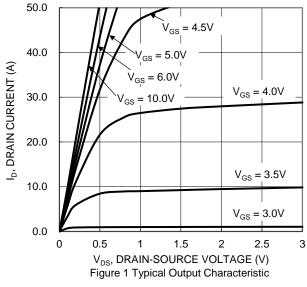
Electrical Characteristics (@TA = +25°C, unless otherwise specified.)

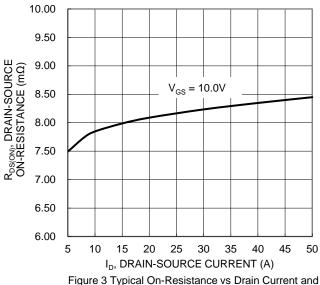
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 8)	Cymbol		1.75	INUX	Oine	rest condition	
Drain-Source Breakdown Voltage	BVDSS	40	_	_	V	$V_{GS} = 0V, I_{D} = 250\mu A$	
Zero Gate Voltage Drain Current	IDSS	_	_	1	μΑ	V _{DS} = 40V, V _{GS} = 0V	
Gate-Source Leakage	I _{GSS}	_	_	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 8)							
Gate Threshold Voltage	V _{GS(TH)}	2	_	4	V	$V_{DS} = V_{GS}$, $I_D = 250\mu A$	
Static Drain-Source On-Resistance	RDS(ON)	_	8.5	10	mΩ	V _G S = 10V, I _D = 50A	
Diode Forward Voltage	VsD	_	0.9	1.2	V	Vgs = 0V, Is = 50A	
DYNAMIC CHARACTERISTICS (Note 9)							
Input Capacitance	Ciss	_	1405	_			
Output Capacitance	Coss	_	247	_	pF	$V_{DS} = 20V, V_{GS} = 0V, f = 1MHz$	
Reverse Transfer Capacitance	Crss	_	108	_			
Gate Resistance	Rg	_	2.2	_	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$	
Total Gate Charge	Qg	_	25.5	_			
Gate-Source Charge	Qgs	_	4.6	_	nC	V _{DS} = 20V, V _{GS} = 10V, I _D = 50A	
Gate-Drain Charge	Qgd	_	6.9	_			
Turn-On Delay Time	t _D (ON)	_	4.6	_			
Turn-On Rise Time	t _R	_	3.7	_		$V_{DD} = 20V, V_{GS} = 10V,$ $I_{D} = 50A, R_{G} = 3.5\Omega$	
Turn-Off Delay Time	tD(OFF)	_	16	_	ns		
Turn-Off Fall Time	tF	_	5.1	_			
Body Diode Reverse Recovery Time	trr	_	22.1	_	ns	- 50A II/II 400A/	
Body Diode Reverse Recovery Charge	QRR	_	13.4	_	nC	$I_F = 50A$, di/dt = 100A/ μ s	

Notes:

- 6. Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1inch square copper plate.
 7. Thermal resistance from junction to soldering point (on the exposed drain pad).
 8. Short duration pulse test used to minimize self-heating effect.
 9. Guaranteed by design. Not subject to production testing.



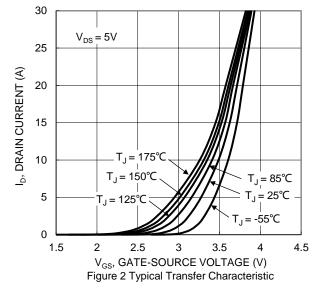


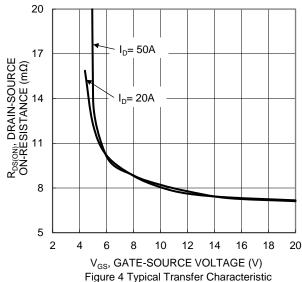


0.02 $T_{J} = 150^{\circ}C$ $V_{GS} = 10V$ 0.018 T_J = 175°C 0.016 R_{DS(ON)}, DRAIN-SOURCE ON-RESISTANCE (Ω) 0.014 $T_{\rm J} = 125^{\circ}{\rm C}$ 0.012 0.01 $T_J = 85^{\circ}C$ 0.008 T_{.1} = 25°C 0.006 0.004 T_J = -55°C 0.002 0 5 20 25 30 35 40 50 0 10 15 45

I_D, DRAIN CURRENT (A)
Figure 5 Typical On-Resistance vs Drain Current
and Temperature

Gate Voltage





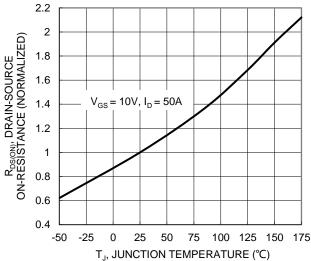


Figure 6 On-Resistance Variation with Temperature



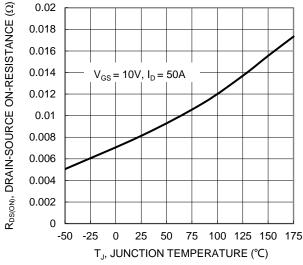
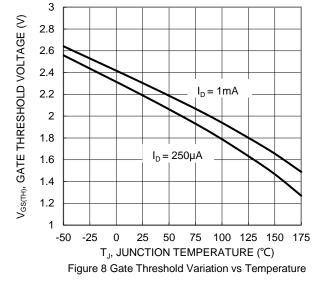
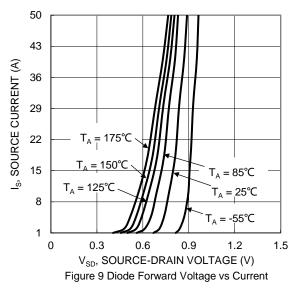
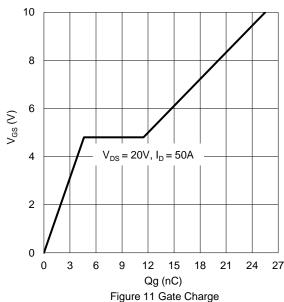
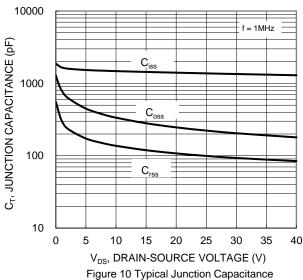


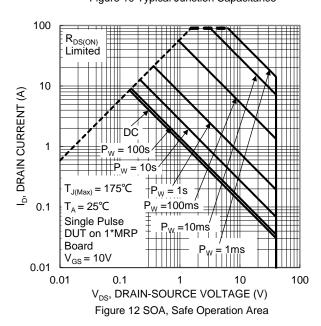
Figure 7 On-Resistance Variation with Temperature













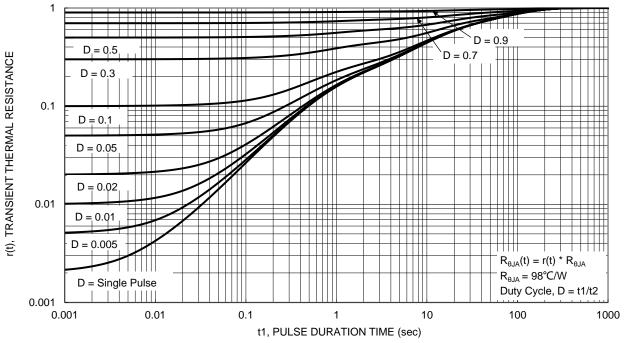


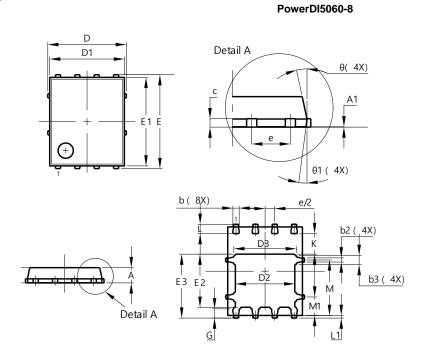
Figure 13 Transient Thermal Resistance



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

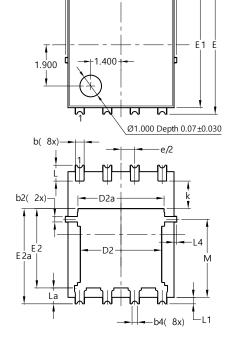
Site 1:



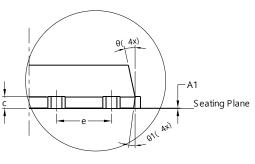
PowerDI5060-8				
Dim	Min	Max	Тур	
Α	0.90	1.10	1.00	
A1	0.00	0.05	-	
b	0.33	0.51	0.41	
b2	0.200	0.350	0.273	
b3	0.40	0.80	0.60	
С	0.230	0.330	0.277	
D	·,	5.15 BSC	;	
D1	4.70	5.10	4.90	
D2	3.70	4.10	3.90	
D3	3.90	4.30	4.10	
E	(6.15 BSC	;	
E1	5.60	6.00	5.80	
E2	3.28	3.68	3.48	
E3	3.99	4.39	4.19	
е		1.27 BSC	;	
G	0.51	0.71	0.61	
K	0.51	-	-	
L	0.51	0.71	0.61	
L1	0.100	0.200	0.175	
М	3.235	4.035	3.635	
M1	1.00	1.40	1.21	
Θ	10°	12°	11°	
Θ1	6°	8°	7°	
All	Dimens	ions in n	nm	

Site 2:

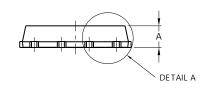
PowerDI5060-8/SWP (Type UX)



D1



DETAIL A



PowerDI5060-8/SWP				
(Type UX)				
Dim	Min	Max	Тур	
Α	0.90	1.10	1.00	
A1	0	0.05		
b	0.30	0.50	0.41	
b2	0.20	0.35	0.25	
b4	C).25REF	-	
С	0.230	0.330	0.277	
D	5	.15 BS0	\sim	
D1	4.70	5.10	4.90	
D2	3.56	3.96	3.76	
D2a	3.78	4.18	3.98	
E	6	.40 BS0		
E1	5.60	6.00	5.80	
E2	3.46	3.86	3.66	
E2a	4.195	4.595	4.395	
е	1.27BSC			
k	1.05			
L	0.635	0.835	0.735	
La	0.635	0.835	0.735	
L1	0.200	0.400	0.300	
L1a	0.050REF			
L4	0.025	0.225	0.125	
М	3.205	4.005	3.605	
θ	10°	12°	11°	
θ1	6°	8°	7°	
All Dimensions in mm				

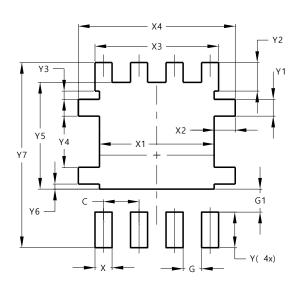


Suggested Pad Layout

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Site 1:

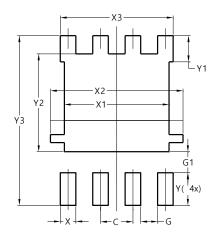
PowerDI5060-8



Dimensions	Value (in mm)
С	1.270
G	0.660
G1	0.820
Х	0.610
X1	4.100
X2	0.755
Х3	4.420
X4	5.610
Υ	1.270
Y1	0.600
Y2	1.020
Y3	0.295
Y4	1.825
Y5	3.810
Y6	0.180
Y7	6.610

Site 2:

PowerDI5060-8/SWP (Type UX)



Dimensions	Value (in mm)
С	1.270
G	0.660
G1	0.820
Х	0.610
X1	4.100
X2	5.190
Х3	4.420
Υ	1.270
Y1	1.020
Y2	3.810
Y3	6.610



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